





Detector R&D towards the International Linear Collider

Status Report TPC Task

Klaus Dehmelt DESY EUDET Extended Steering Committee-Meeting 31-August-2010



Main objective: Large Prototype (LP) of a TPC at the DESY testbeam T24/1.

Achievements

IIL

- Oct-2008: Field cage available
- Nov-2008: First cosmics with MicroMegas/AFTER electronics in LP
- Dec-2008: First testbeam/JRA1 with MicroMegas/AFTER electronics in LP







Main objective: Large Prototype (LP) of a TPC at the DESY testbeam T24/1.

Achievements

- Mar-2009: First cosmics/testbeam/JRA1 with JGEM/Altro electronics in LP
- May-2009: Data taking/JRA1 with MicroMegas/AFTER electronics in LP and laser setup (Victoria Univ.)
- Jun-2009: First cosmics/testbeam/JRA1 with BGEM/TimePix in LP







Main objective: Large Prototype (LP) of a TPC at the DESY testbeam T24/1.

Achievements

- Jul-2009: Installation of movable stage
- Jul-2009: Data taking/JRA1 with JGEM/ALTRO electronics in LP
- Sep-2009: First cosmics/testbeam/JRA1 with BGEM/Altro electronics in LP
- Nov-2009: Common data taking/JRA1 with MicroMegas/AFTER electronics in LP and Si modules in PCMAG







Main objective: Large Prototype (LP) of a TPC at the DESY testbeam T24/1.

Achievements

IIL

- Mar-2010: Data taking/JRA1 with MicroMegas/AFTER electronics in LP
- Mar-2010: Data taking/JRA1 with JGEM/ALTRO electronics in LP















DESY Setup









• Requirements:

IIL

- Dimensions
 - diameter = O(800 mm), length = O(600 mm)

Field Cage

- Lightweight field cage, though stable and flexible to use
- Homogeneous electrical field



Klaus Dehmelt





Klaus Dehmelt





31-August-2010









MicroMeGaS for LP: 24 rows x 72 pads Av. Pad size: 3.2 x 7mm²

P. Colas, CEA Saclay M.S.Dixit, Carleton University



Readout electronics: AFTER (T2K TPC)



No resistive layer Resistive Kapton Resistive ink













28 pad raws (176/192 pads/raw)



Extended SC Meeting









Readout electronics: Based on ALTRO (ALICE TPC) L. Joensson, LUND University

Up to 10k channels readout electronics



31-August-2010



Klaus Dehmelt



Three-fold readout electronics:

- <u>ALICE</u> based: new PCA16 amplifier chip + ALTRO chip (EUDET & LCTPC)
 - LCTPC) \rightarrow adopted to ILC environment; designed within EUDET DAQ scheme
- <u>T2K</u> based: AFTER electronics for T2K TPC (CEA Saclay)
- <u>TDC</u> based: ASDQ chip + TDC (EUDET & Uni Rostock)

AFTER electronics for MicroMeGAS (resistive anode readout) ALTRO and TDC based electronics will be hooked to the GEM detector modules (connector compatibility)





ALTRO Electronics & DAQ



Based on ALTRO chip, developed for ALICE

- 16 ch analog to digital conversion with 10 bit precision
- Digital signal processing, including zero suppression and storage in event buffer
- Sampling up to 40 MHz
- Event storage memory of 1k 10bit words \rightarrow 50 μs drift time @ 20MHz

 \rightarrow v_{drift} = 7cm/µs: L_{drift,max} = 350 cm

- PCA16 chip with different choices: w.r.t. peaking time, gain, decay time and signal polarity
- Modifications to FEC: programmability, can be done remotely
- Typical measurement with 120 ns peaking time (max) and lowest gain (12mV/fC) shows RMS value of ~0.5 ADC counts \rightarrow ENC of 260 e⁻
- At highest gain (27mV/fC) ~1 ADC counts \rightarrow ENC of 231 e⁻







ALTRO Electronics & DAQ

FEC



- Each FEC contains 8 PCA16 & 8 ALTRO chips \rightarrow 128 ch
- Readout Control Unit (RCU) responsible for readout of data via backplane, up to 32 FECs
- Optical fiber for data transmission
- Received by Detector Read-Out Receiver Card (DRORC), placed in DAQ PC
- Trigger and Timing Control by Trigger Logic Unit (TLU)
- Triggers from TLU received by distribution box (DBOX) and sent via RCU to FECs 2048ch.16 FEC



ΪįĹ



Readout Electronics: TDC





• The charge of the input signal is encoded into the width of output digital pulse.

A. Kaukher, Univ. Rostock

Klaus Dehmelt

IIL









anode plane

GEMs

readout plane

quad-boards reinforcement of anode plane

redframe

Readout: 2 quadboards (4 TimePix Chips each)

J. Kaminski, Univ. of Bonn

Klaus Dehmelt





LP Mechanics









Design Study of the Magnetmovementtable

Support structures:

• TPC

IIL

- PCMAG
- F. Hegner, V. Prahl, R. Volkenborn, DESY







LP Mechanics









Si Envelope





Combined test beam campaign with two Micromegas modules in Nov. 2009

S. Haensel HEPHY Vienna





Laser Calibration Setup





Pattern seen with Micromegas





31-August-2010

ΪĹ



Extended SC Meeting







- Field cage, cathode end plate / alignment wheel, cathodes as part of the LP, one cathode patterned
- 10k channels of ALTRO electronics have been produced and tested
- 6k channels of ALTRO electronics in use
- S-ALTRO development under way
- TLU trigger system available











- Gas-/HV-infrastructure
- Infrastructure for LP present and being used
- Infrastructure for SiLC envelope installed
- LP assembled, commissioned and being tested
- LP with three different amplification technologies operated
- First SiLC run performed
- ~20 weeks of test beam with LP operation so far
- >10M events recorded \rightarrow ~2TB data on GRID
- \rightarrow more to come









• We have built and assembled / tested / commissioned a Large Prototype of a TPC (EUDET and LCTPC collaboration)

- Two MPGD technologies (with three electronics techniques) have been tested:
 - Micromegas (AFTER electronics)
 - ★ GEM (ALTRO, TimePix)
- Infrastructure for Large Prototype has been constructed
- *e*⁻ test beam (DESY) in conjunction with PCMAG (*1T* magnet)
- Preliminary results are looking very promising
- Accomplishment of assigned goals









- Items not yet completed:
 - Alignment system for LP within PCMAG to be tested/installed
 - Slow control to be (further) developed
 - Automation of processes
 - DESY GEM module
- Further test beam campaigns for this year:
 - Backplane integrated 10,000 channel readout system, based on ALTRO electronics
 - Seven Micromegas modules with AFTER electronics attached to the modules (?)
 - DESY-GEM module with ALTRO electronics

• PCMAG modifications in 2011





